

Technical Data Sheet

Schulamid 66 GB 30

Polyamide 66
LyondellBasell Industries
Engineering Plastics

Product Description

30% glass bead filled PA66

General

- Filler / Reinforcement • Glass Bead, 30% Filler by Weight
- Processing Method • Injection Molding

Physical	Dry	Conditioned	Unit	Test Method
Density	1.35	--	g/cm ³	ISO 1183/A
Viscosity Number	140	--	cm ³ /g	ISO 307
Mechanical	Dry	Conditioned	Unit	Test Method
Tensile Modulus	653000 (4500)	363000 (2500)	psi (MPa)	ISO 527-1/1A/1
Tensile Stress (Break)	13800 (95.0)	9430 (65.0)	psi (MPa)	ISO 527-2/1A/5
Tensile Strain (Break)	7.5	11	%	ISO 527-2/1A/5
Impact	Dry	Conditioned	Unit	Test Method
Charpy Notched Impact Strength (73°F (23°C))	1.9 (4.0)	--	ft·lb/in ² (kJ/m ²)	ISO 179/1eA
Charpy Unnotched Impact Strength 73°F (23°C)	14 (30)	--	ft·lb/in ² (kJ/m ²)	ISO 179/1eU
Hardness	Dry	Conditioned	Unit	Test Method
Ball Indentation Hardness (H 358/30)	26800 (185)	--	psi (MPa)	ISO 2039-1
Thermal	Dry	Conditioned	Unit	Test Method
Deflection Temperature Under Load 264 Psi (1.8 Mpa), Unannealed	194 (90.0)	--	°F (°C)	ISO 75-2/ Af
Ball Pressure Test (257°F (125°C))	Pass	--		IEC 60695-10-2
Electrical	Dry	Conditioned	Unit	Test Method
Surface Resistivity	> 1.0E+15	--	ohms	IEC 60093
Volume Resistivity	> 1.0E+13	1.0E+10	ohms·m	IEC 62631-3-1
Comparative Tracking Index	450	--	V	IEC 60112
Flammability	Dry	Conditioned	Unit	Test Method
Burning Rate				
0.0787 In (2.00 Mm)	< 3.9 (< 100)	--	in/min (mm/min)	ISO 3795
0.0787 In (2.00 Mm)	< 3.9 (< 100)	--	in/min (mm/min)	FMVSS 302
Glow Wire Flammability Index	1200 (650)	--	°F (°C)	IEC 60695-2-12

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Injection	Dry (English)	Dry (SI)
Drying Temperature	176 °F	80 °C
Drying Time	3.0 to 4.0 hr	3.0 to 4.0 hr
Suggested Max Moisture	0.04 to 0.10 %	0.04 to 0.10 %
Processing (Melt) Temp	536 to 572 °F	280 to 300 °C
Mold Temperature	140 to 248 °F	60 to 120 °C

Notes

These are typical property values not to be construed as specification limits.